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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Choi *et al.*

Examiner: Zimmerman, John J.

OFFICIAL

Serial No.: 10/078,020

Art Unit: 1775

Filed: 2/15/2002

For: LEAD-FREE TIN-SILVER-COPPER ALLOY SOLDER COMPOSITION

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

AMENDMENT

Sir:

In response to the Office Action mailed October 2, 2003, please amend the above-identified application as follows:

03/25/2004 TC0LE1 00000001 090457 10078020  
01 FC:1201 258.00 DA

10/078,020

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